

## Improved Quad CMOS Analog Switches

### Features

- $\pm 22$ -V Supply Voltage Rating
- TTL and CMOS Compatible Logic
- Low On-Resistance— $r_{DS(on)}$ : 50  $\Omega$
- Low Leakage— $I_{D(on)}$ : 20 pA
- Single Supply Operation Possible
- Extended Temperature Range
- Fast Switching— $t_{ON}$ : 120 ns
- Low Charge Injection—Q: 1 pC

### Benefits

- Wide Analog Signal Range
- Simple Logic Interface
- Higher Accuracy
- Minimum Transients
- Reduced Power Consumption
- Superior to DG211/212

### Applications

- Industrial Instrumentation
- Test Equipment
- Communications Systems
- Disk Drives
- Computer Peripherals
- Portable Instruments
- Sample-and-Hold Circuits

### Description

The DG211B/212B analog switches are highly improved versions of the industry-standard DG211/212. These devices are fabricated in Siliconix' proprietary silicon gate CMOS process, resulting in lower on-resistance, lower leakage, higher speed, and lower power consumption.

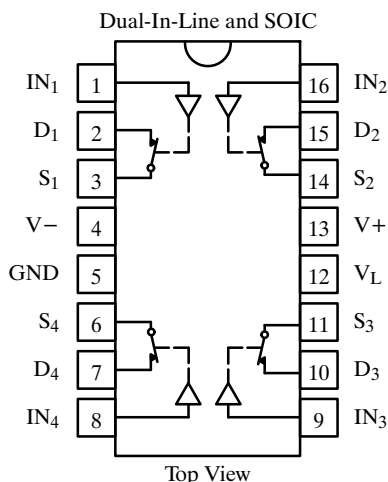
These quad single-pole single-throw switches are designed for a wide variety of applications in telecommunications, instrumentation, process control, computer peripherals, etc. An improved charge

injection compensation design minimizes switching transients. The DG211B and DG212B can handle up to  $\pm 22$  V, and have an improved continuous current rating of 30 mA. An epitaxial layer prevents latchup.

All devices feature true bi-directional performance in the on condition, and will block signals to the supply levels in the off condition.

The DG211B is a normally closed switch and the DG212B is a normally open switch. (See Truth Table.)

### Functional Block Diagram and Pin Configuration



Truth Table

Logic	DG211B	DG212B
0	ON	OFF
1	OFF	ON

Logic "0"  $\leq 0.8$  V  
 Logic "1"  $\geq 2.4$  V

Switches Shown for Logic "0" Input

Ordering Information

Temp Range	Package	Part Number
-40 to 85°C	16-Pin Plastic DIP	DG211BDJ
		DG212BDJ
	16-Pin Narrow SOIC	DG211BDY
		DG212BDY

# DG211B/212B

## Absolute Maximum Ratings

Voltages Referenced to V-

V+ ..... 44 V

GND ..... 25 V

Digital Inputs<sup>a</sup> V<sub>S</sub>, V<sub>D</sub> ..... (V-) -2 V to (V+) +2 V  
or 30 mA, whichever occurs first

Current, Any Terminal ..... 30 mA

Peak Current, S or D

(Pulsed at 1 ms, 10% duty cycle max) ..... 100 mA

Storage Temperature ..... -65 to 125°C

Power Dissipation (Package)<sup>b</sup>

16-Pin Plastic DIP<sup>c</sup> ..... 470 mW

16-Pin Narrow SOIC<sup>d</sup> ..... 640 mW

Notes

a. Signals on S<sub>X</sub>, D<sub>X</sub>, or IN<sub>X</sub> exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

b. All leads welded or soldered to PC Board.

c. Derate 6.5 mW/°C above 75°C

d. Derate 7.6 mW/°C above 75°C

## Specifications

Parameter	Symbol	Test Conditions Unless Otherwise Specified V+ = 15 V, V- = -15 V V <sub>L</sub> = 5 V, V <sub>IN</sub> = 2.4 V, 0.8 V <sup>e</sup>	Temp <sup>a</sup>	D Suffix -40 to 85°C			Unit
				Min <sup>c</sup>	Typ <sup>b</sup>	Max <sup>c</sup>	
<b>Analog Switch</b>							
Analog Signal Range <sup>d</sup>	V <sub>ANALOG</sub>		Full	-15		15	V
Drain-Source On-Resistance	r <sub>DS(on)</sub>	V <sub>D</sub> = ±10 V, I <sub>S</sub> = 1 mA	Room		45	85	Ω
r <sub>DS(on)</sub> Match	Δr <sub>DS(on)</sub>		Full			100	
Source Off Leakage Current	I <sub>S(off)</sub>	V <sub>S</sub> = ±14 V, V <sub>D</sub> = ∓14 V	Room	-0.5	±0.01	0.5	nA
Drain Off Leakage Current	I <sub>D(off)</sub>	V <sub>D</sub> = ±14 V, V <sub>S</sub> = ∓14 V	Full	-5		5	
Drain On Leakage Current	I <sub>D(on)</sub>	V <sub>S</sub> = V <sub>D</sub> = 14 V	Room	-0.5	±0.01	0.5	
			Full	-10	±0.02	10	
<b>Digital Control</b>							
Input Voltage High	V <sub>INH</sub>		Full	2.4			V
Input Voltage Low	V <sub>INL</sub>		Full			0.8	
Input Current	I <sub>INH</sub> or I <sub>INL</sub>	V <sub>INH</sub> or V <sub>INL</sub>	Full	-1		1	μA
Input Capacitance	C <sub>IN</sub>		Room		5		pF
<b>Dynamic Characteristics</b>							
Turn-On Time	t <sub>ON</sub>	V <sub>S</sub> = 2 V See Figure 2	Room		85	150	ns
Turn-Off Time	t <sub>OFF</sub>		Room		77	120	
Charge Injection	Q	C <sub>L</sub> = 1000 pF, V <sub>g</sub> = 0 V, R <sub>g</sub> = 0 Ω	Room		1		pC
Source-Off Capacitance	C <sub>S(off)</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	Room		5		pF
Drain-Off Capacitance	C <sub>D(off)</sub>		Room		5		
Channel On Capacitance	C <sub>D(on)</sub>		Room		16		
Off Isolation	OIRR	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 50 Ω V <sub>S</sub> = 1 V <sub>RMS</sub> , f = 100 kHz	Room		90		dB
Channel-to-Channel Crosstalk	X <sub>TALK</sub>		Room		95		

## Specifications

Parameter	Symbol	Test Conditions Unless Otherwise Specified $V_+ = 15\text{ V}, V_- = -15\text{ V}$ $V_L = 5\text{ V}, V_{IN} = 2.4\text{ V}, 0.8\text{ V}^e$	Temp <sup>a</sup>	D Suffix -40 to 85°C			Unit
				Min <sup>c</sup>	Typ <sup>b</sup>	Max <sup>c</sup>	
<b>Power Supply</b>							
Positive Supply Current	I+	$V_{IN} = 0\text{ or }5\text{ V}$	Room Full			10 50	μA
Negative Supply Current	I-		Room Full	-10 -50			
Logic Supply Current	I <sub>L</sub>	Room Full			10 50		
Power Supply Range for Continuous Operation	V <sub>OP</sub>		Full	±4		±22	V

## Specifications for Single Supply

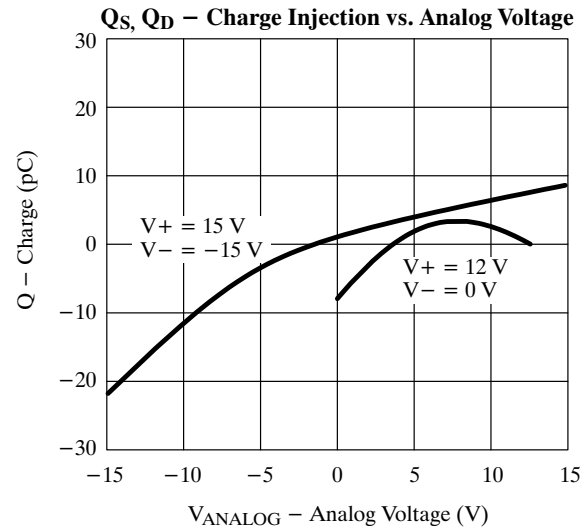
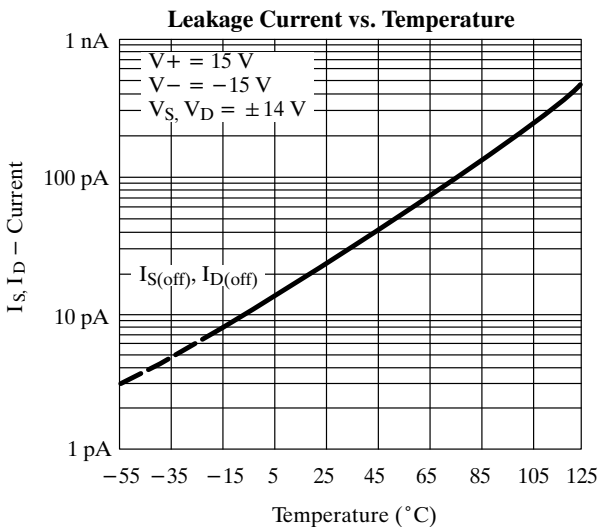
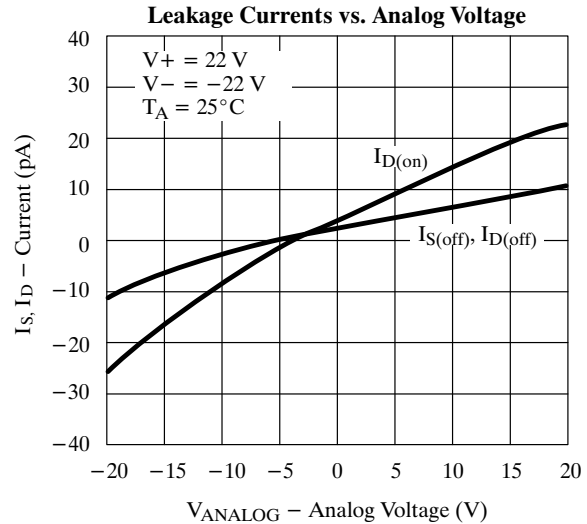
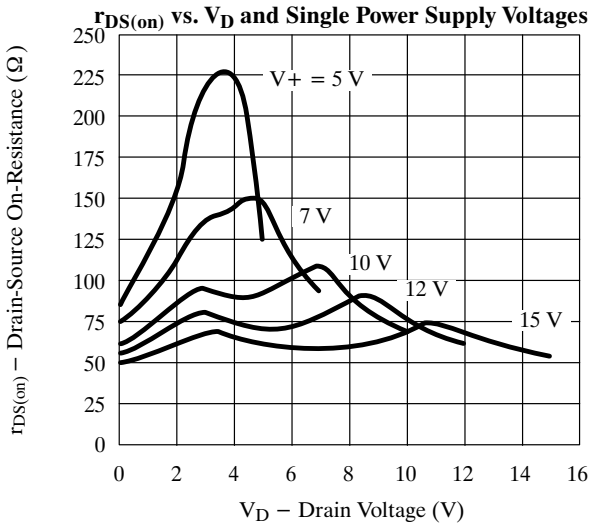
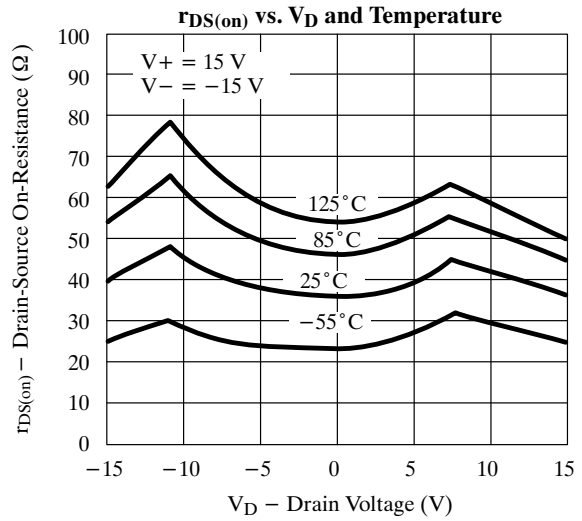
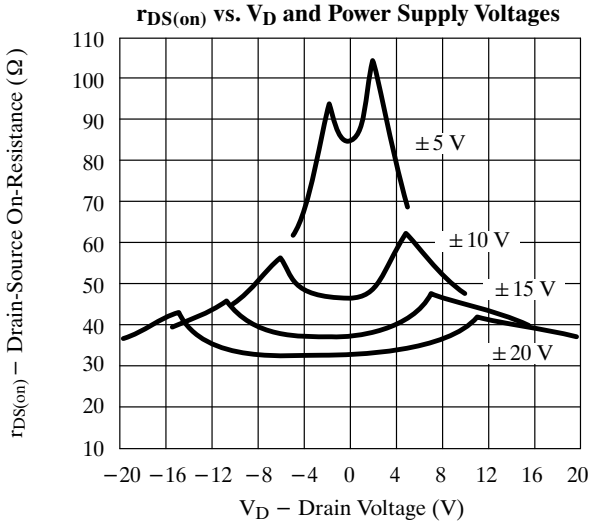
Parameter	Symbol	Test Conditions Unless Otherwise Specified $V_+ = 12\text{ V}, V_- = 0\text{ V}$ $V_L = 5\text{ V}, V_{IN} = 2.4\text{ V}, 0.8\text{ V}^e$	Temp <sup>a</sup>	D Suffix -40 to 85°C			Unit
				Min <sup>c</sup>	Typ <sup>b</sup>	Max <sup>c</sup>	
<b>Analog Switch</b>							
Analog Signal Range <sup>d</sup>	V <sub>ANALOG</sub>		Full	0		12	V
Drain-Source On-Resistance	r <sub>DS(on)</sub>	$V_D = 3\text{ V}, 8\text{ V}, I_S = 1\text{ mA}$	Room Full		90	160 200	Ω
<b>Dynamic Characteristics</b>							
Turn-On Time	t <sub>ON</sub>	$V_S = 8\text{ V}$ See Figure 2	Room			300	ns
Turn-Off Time	t <sub>OFF</sub>		Room			200	
Charge Injection	Q	$C_L = 1\text{ nF}, V_{gen} = 6\text{ V}, R_{gen} = 0\text{ Ω}$	Room		4		pC
<b>Power Supply</b>							
Positive Supply Current	I+	$V_{IN} = 0\text{ or }5\text{ V}$	Room Full			10 50	μA
Negative Supply Current	I-		Room Full	-10 -50			
Logic Supply Current	I <sub>L</sub>	Room Full			10 50		
Power Supply Range for Continuous Operation	V <sub>OP</sub>		Full	+4		+44	V

### Notes

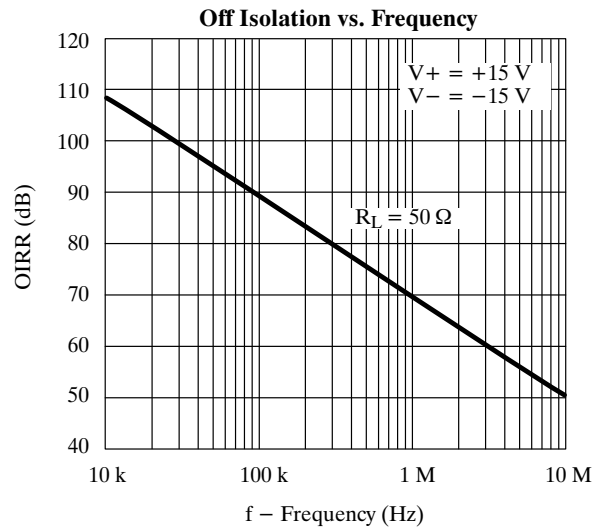
- Room = 25°C, Full = as determined by the operating temperature suffix.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- Guaranteed by design, not subject to production test.
- $V_{IN}$  = input voltage to perform proper function.

## DG211B/212B

### Typical Characteristics



## Typical Characteristics (Cont'd)



## Schematic Diagram (Typical Channel)

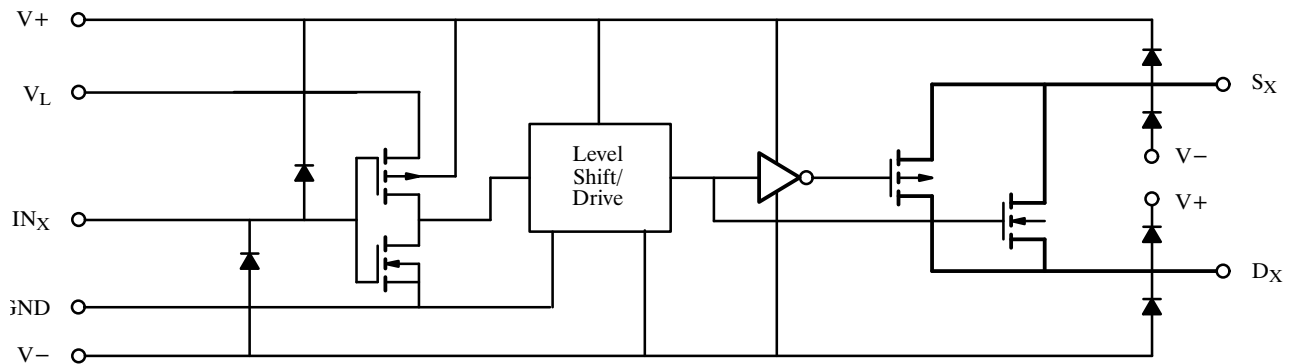


Figure 1.

## Test Circuits

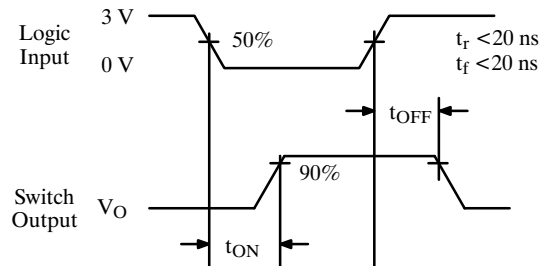
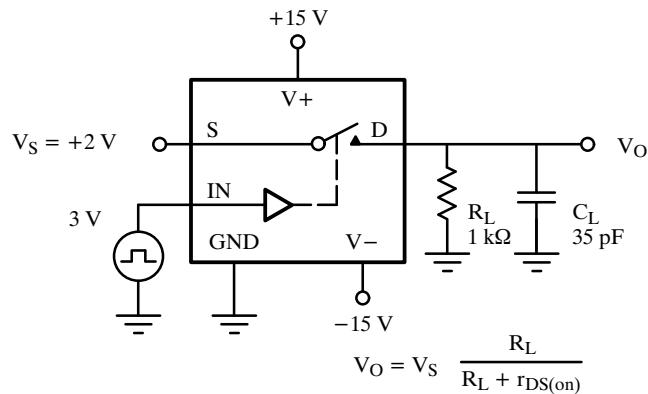


Figure 2. Switching Time

## DG211B/212B

### Test Circuits (Cont'd)

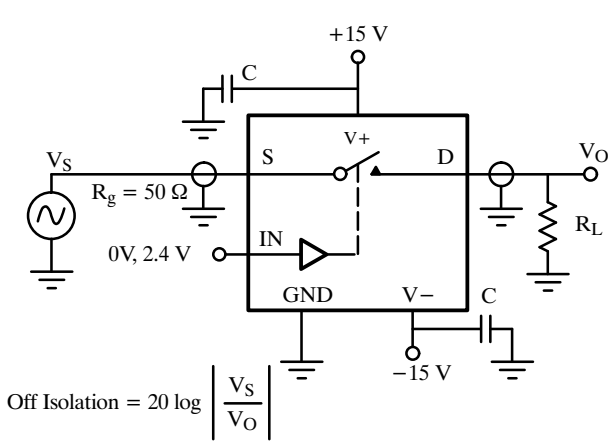


Figure 3. Off Isolation

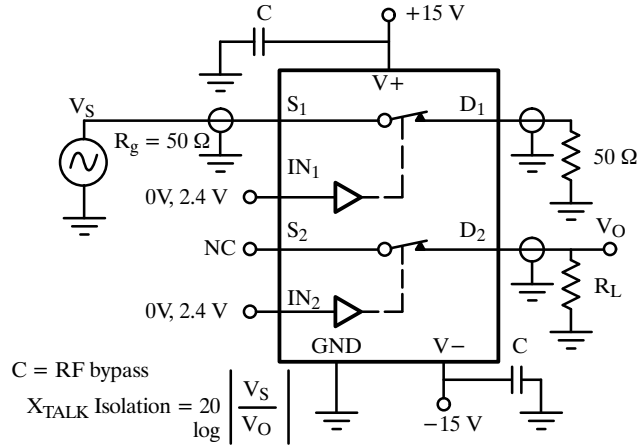
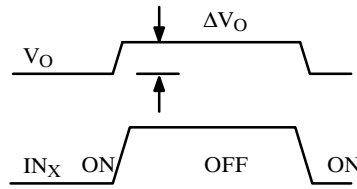
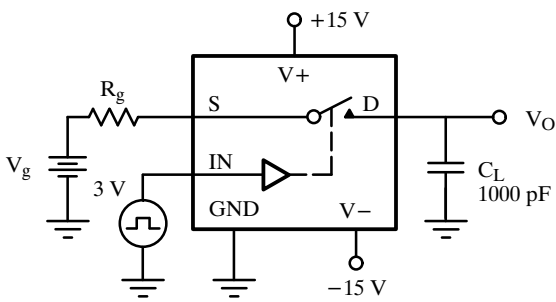


Figure 4. Channel-to-Channel Crosstalk



$\Delta V_O =$  measured voltage error due to charge injection  
The charge injection in coulombs is  $Q = C_L \times \Delta V_O$

Figure 5. Charge Injection

### Applications

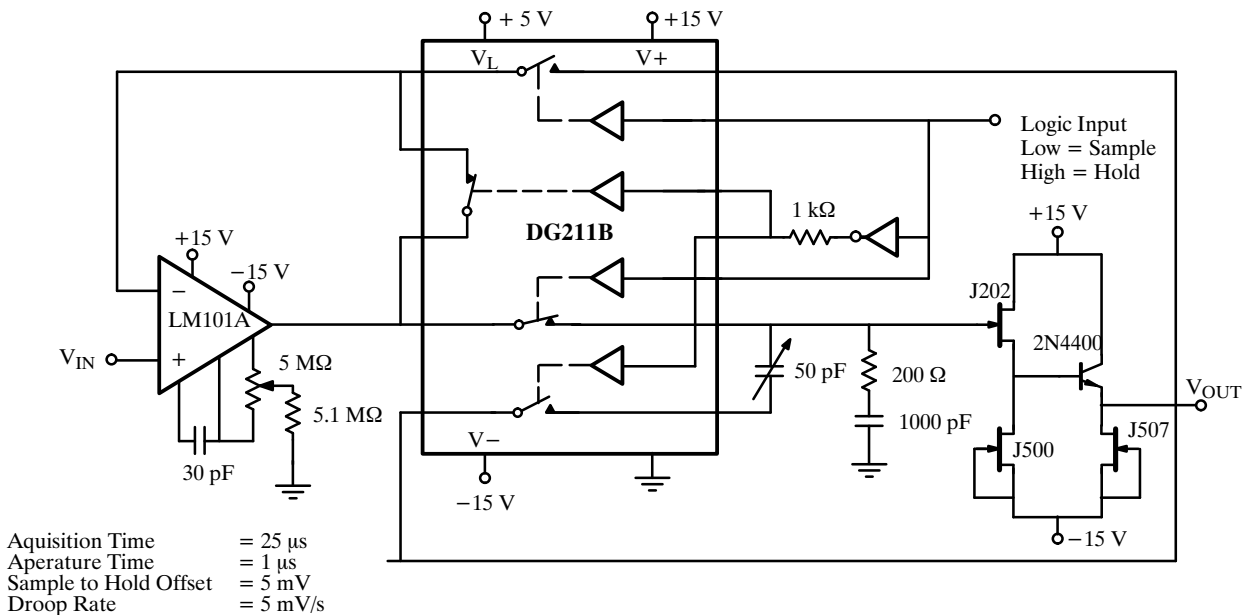


Figure 6. Sample-and-Hold

## Applications (Cont'd)

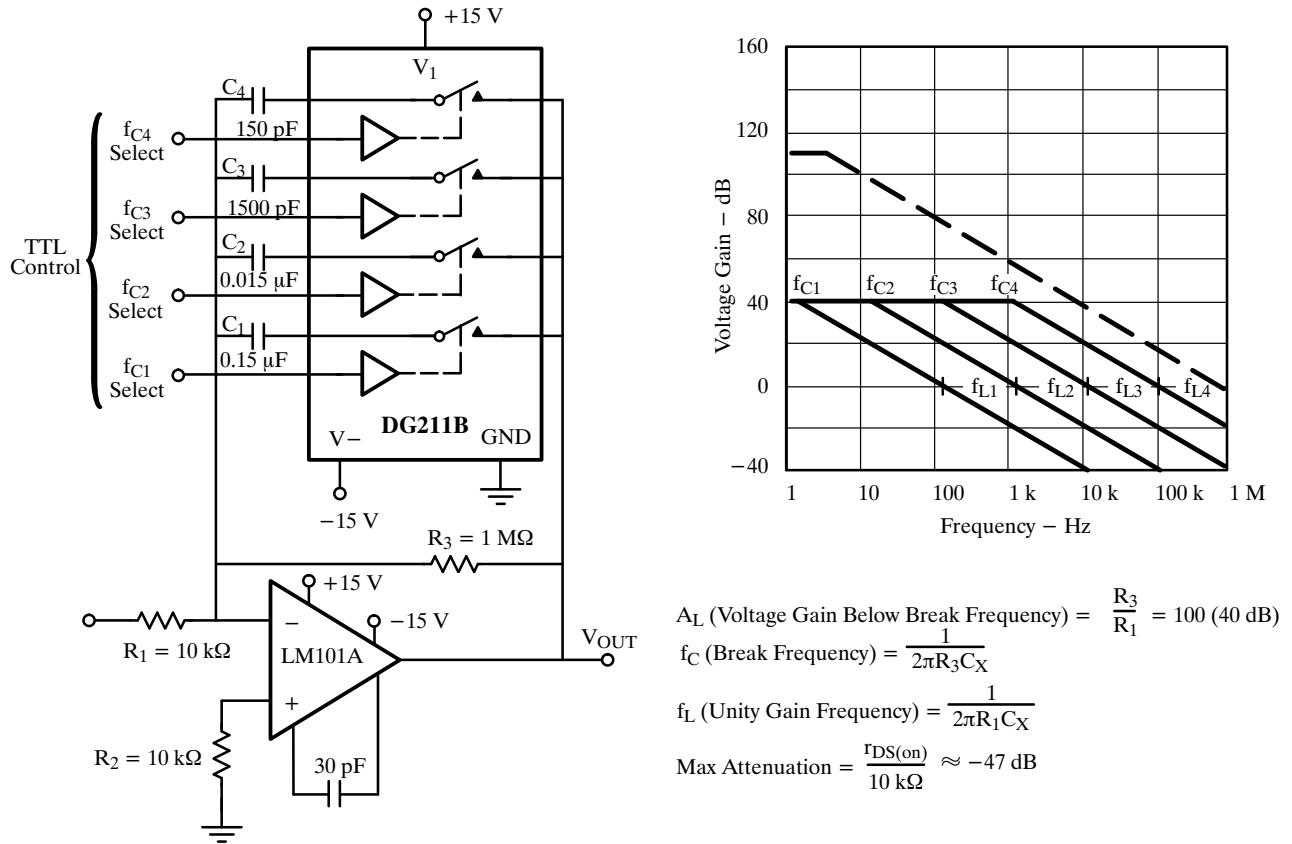


Figure 7. Active Low Pass Filter with Digitally Selected Break Frequency

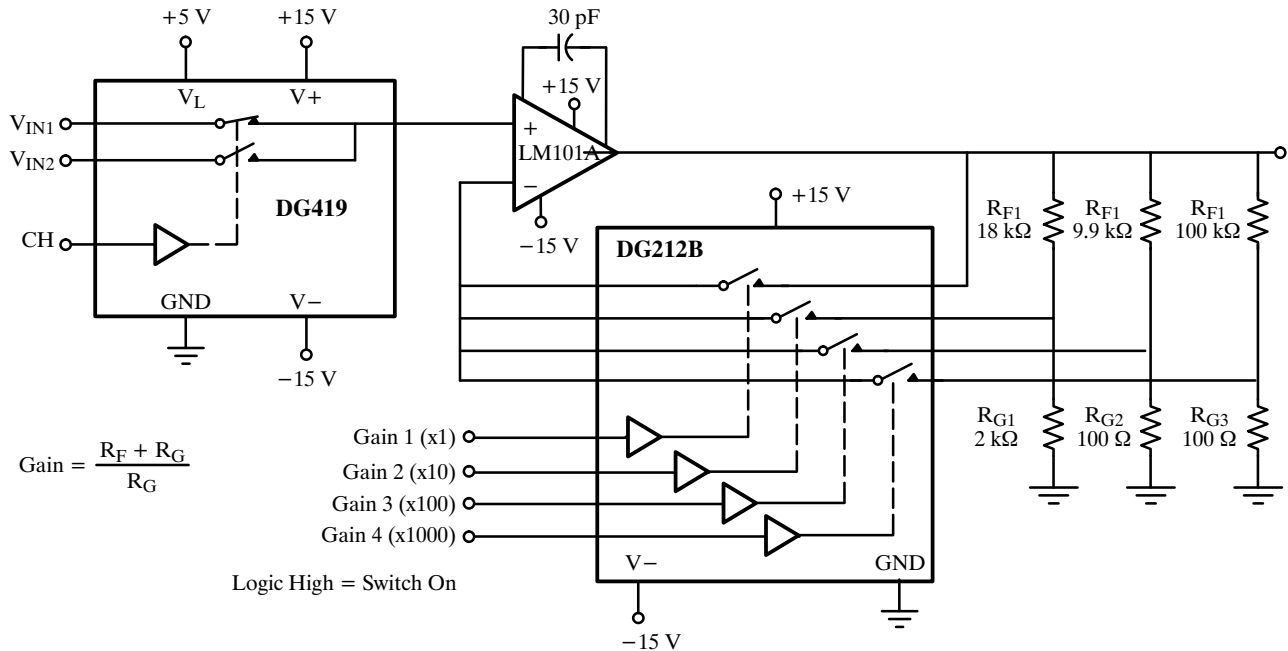


Figure 8. A Precision Amplifier with Digitally Programmable Input and Gains